

Vishay Siliconix

RoHS

COMPLIANT HALOGEN

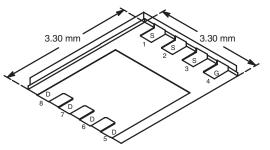
FREE

Available

P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	R _{DS(on)} (Ω) I _D (A)			
- 30	0.019 at V _{GS} = - 4.5 V	- 11	25		
	0.031 at V _{GS} = - 2.5 V	- 8.5	25		

PowerPAK 1212-8



Bottom View

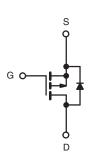
Ordering Information: Si7409ADN-T1-E3 (Lead (Pb)-free) Si7409ADN-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile
- V_{DS} Optimized for Load Switch
- 100 % R_g Tested

APPLICATIONS

Load Switch



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	- 30		V	
Gate-Source Voltage		V _{GS}	± 12			
	T _A = 25 °C	- I _D	- 11	- 7		
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C		- 7.9	- 5		
Pulsed Drain Current		I _{DM}	- 40		A	
Continuous Source Current (Diode Conduction) ^a		۱ _S	- 3.2	- 1.3		
	T _A = 25 °C	- P _D	3.8	1.5	W	
Maximum Power Dissipation ^a	T _A = 85 °C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260		°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Manimum has bien to Anabien 18	t ≤ 10 s	R _{thJA}	26	33	
Maximum Junction-to-Ambient ^a	Steady State		65	81	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	1.9	2.4	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. See Reliability Manual for profile. The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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SPECIFICATIONS T _J = 25 °C Parameter	Symbol Test Conditions			Typ.	Max.	Unit	
Static	Symbol	Test conditions	Min.	Typ.	ινιαλ.	Unit	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 0.6		- 1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μΑ	
		V_{DS} = - 30 V, V_{GS} = 0 V, T_{J} = 85 °C			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le$ - 5 V, V_{GS} = - 4.5 V	- 40			А	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 11 A		0.015	0.019	Ω	
Drain-Source On-State Resistance ^a		V _{GS} = - 2.5 V, I _D = - 8.5 A		0.025	0.031		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 11 A		40		S	
Diode Forward Voltage ^a	V _{SD}	I _S = - 3.2 A, V _{GS} = 0 V		- 0.7	- 1.2	V	
Dynamic ^b			•	•			
Total Gate Charge	Qg			25	40	nC	
Gate-Source Charge	Q _{gs}	V_{DS} = - 15 V, V_{GS} = - 4.5 V, I_{D} = - 11 A		5			
Gate-Drain Charge	Q _{gd}			9			
Gate Resistance	Rg	f = 1.0 MHz	3.3	6.5	10	Ω	
Turn-On Delay Time	t _{d(on)}			30	45		
Rise Time	t _r	V_{DD} = - 15 V, R_L = 15 Ω		50	75	ns	
Turn-Off Delay Time	t _{d(off)}	${ m I}_{ m D}\cong$ - 1 A, ${ m V}_{ m GEN}$ = - 4.5 V, ${ m R}_{ m g}$ = 6 Ω		115	175		
Fall Time	t _f			75	115		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 3.2 A, dl/dt = 100 A/μs		60	90		
Reverse Recovery Charge	Q _{rr}	$r_{\rm F} = -0.2$ A, $u/ut = 100$ A/ μ s		100	150	nC	

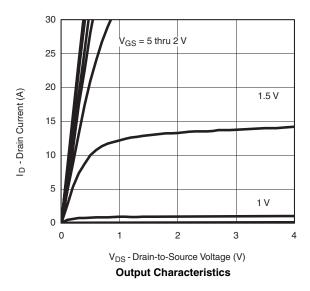
Notes:

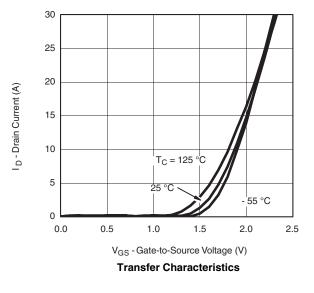
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

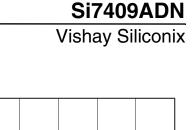
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

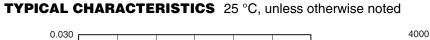
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



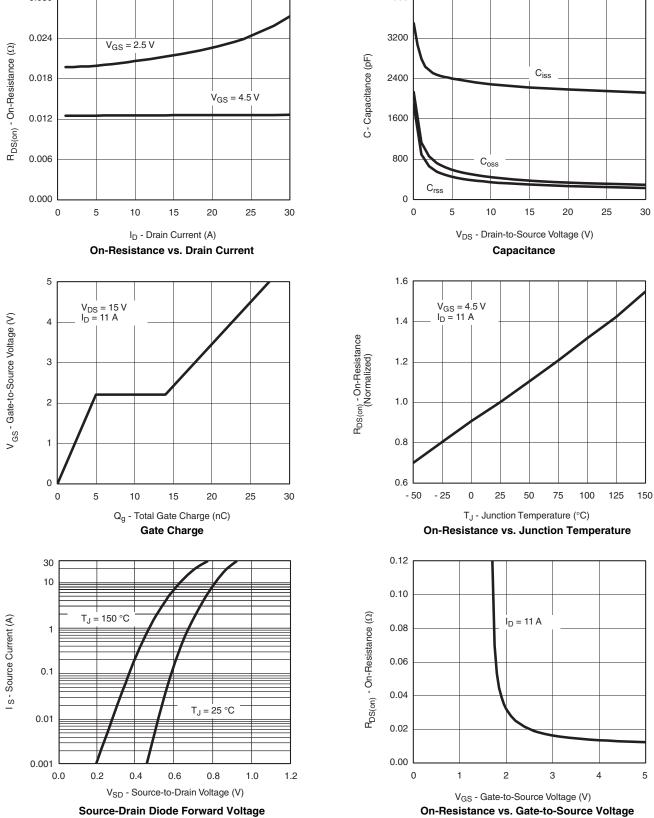


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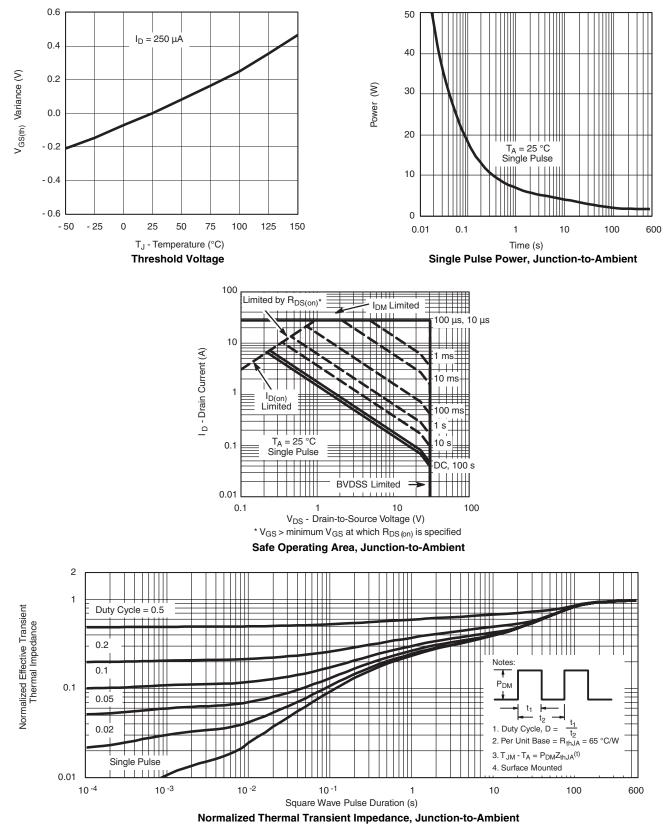


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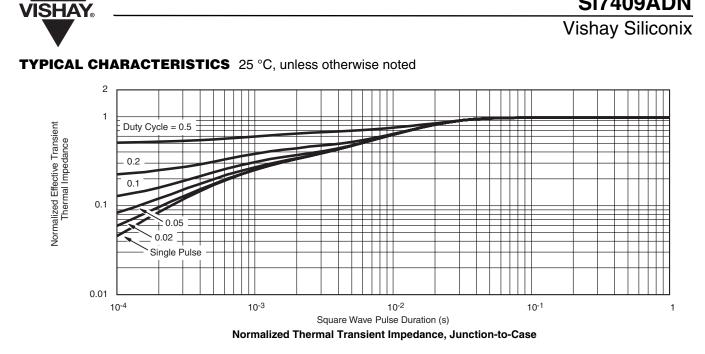
Si7409ADN

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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <u>www.vishay.com/ppg?73246</u>.

Si7409ADN



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